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<u>MOSFET</u> – Power, Single N-Channel

60 V, 25 A, 21 m Ω

NVMFS5C682NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C682NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Parar	Parameter			
V _{DSS}	Drain-to-Source Voltage			60	V
V _{GS}	Gate-to-Source Voltage	Э		±20	V
Ι _D	Continuous Drain	$T_{\rm C} = 25^{\circ}{\rm C}$		25	А
	Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C	18	
PD	Power Dissipation	State	$T_{C} = 25^{\circ}C$	28	W
	R _{θJC} (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	14	
Ι _D	Continuous Drain		T _A = 25°C	8.8	А
	Current R _{θJA} (Notes 1, 2, 3)	Steady	$T_A = 100^{\circ}C$	6.2	
PD	Power Dissipation	State	T _A = 25°C	3.5	W
	$R_{\theta JA}$ (Notes 1 & 2)		T _A = 100°C	1.7	
I _{DM}	Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	130	А
T _J , T _{stg}	Operating Junction and Storage Temperature			–55 to + 175	°C
۱ _S	Source Current (Body Diode)			31	А
E _{AS}	Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 1.1 A)			43	mJ
ΤL	Lead Temperature for S (1/8" from case for 10 s		Purposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State	5.3	°C/W
R_{\thetaJA}	Junction-to-Ambient - Steady State (Note 2)	43	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

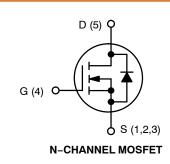
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
60 V	21 mΩ @ 10 V	25 A	
00 V	$31.5~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	237	



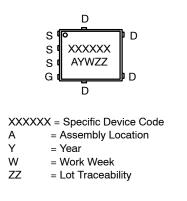


DFN5 CASE 488AA

DFNW5 CASE 507BA



MARKING DIAGRAMS



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet. NOTE: Some of the devices on this data sheet have been

DISCONTINUED. Please refer to the table on page 5.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•					
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 V, I_D$	= 250 μA	60			V
V _{(BR)DSS} / T _J	Drain-to-Source Breakdown Voltage Temperature Coefficient				28		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25 °C			10	
		$V_{DS} = 60 V$	T _J = 125°C			250	μΑ
I _{GSS}	Gate-to-Source Leakage Current	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARA	CTERISTICS (Note 4)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 16 \ \mu A$		1.2		2.0	V
	Threshold Temperature Coefficient				45		m\//°C

$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient			-4.5		mV/°C
R _{DS(on)}	Drain-to-Source On Resistance	V _{GS} = 10 V	I _D = 10 A	18	21	mΩ
		V _{GS} = 4.5 V	I _D = 10 A	26	31.5	11152
9fs	Forward Transconductance	V _{DS} =15 V, I _D = 10 A		17		S

CHARGES AND CAPACITANCES

C _{ISS}	Input Capacitance		410	
C _{OSS}	Output Capacitance	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V	210	pF
C _{RSS}	Reverse Transfer Capacitance		7.0	
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 10 A	2.5	nC
Q _{G(TOT)}	Total Gate Charge	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 10 A	5.0	nC
Q _{G(TH)}	Threshold Gate Charge		0.6	
Q _{GS}	Gate-to-Source Charge		1.0	nC
Q _{GD}	Gate-to-Drain Charge	V _{GS} = 10 V, V _{DS} = 48 V; I _D = 10 A	0.5	
V _{GP}	Plateau Voltage		2.7	V

SWITCHING CHARACTERISTICS (Note 5)

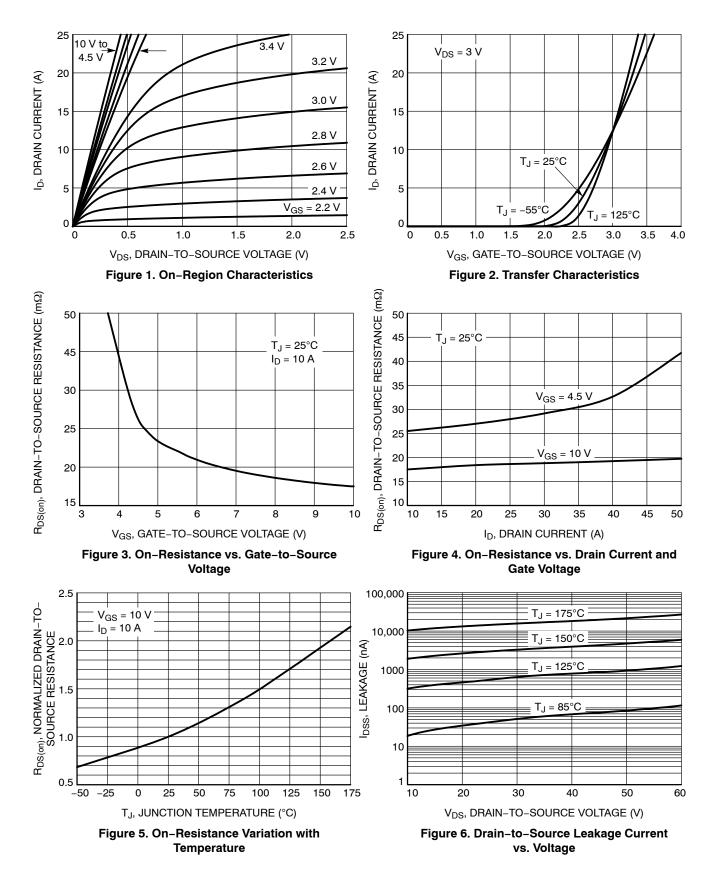
t _{d(ON)}	Turn-On Delay Time		4.0	
t _r	Rise Time	V _{GS} = 10 V, V _{DS} = 48 V,	12	
t _{d(OFF)}	Turn-Off Delay Time	$I_{\rm D}$ = 10 A, $R_{\rm G}$ = 2.5 Ω	12	ns
t _f	Fall Time		1.5	

DRAIN-SOURCE DIODE CHARACTERISTICS

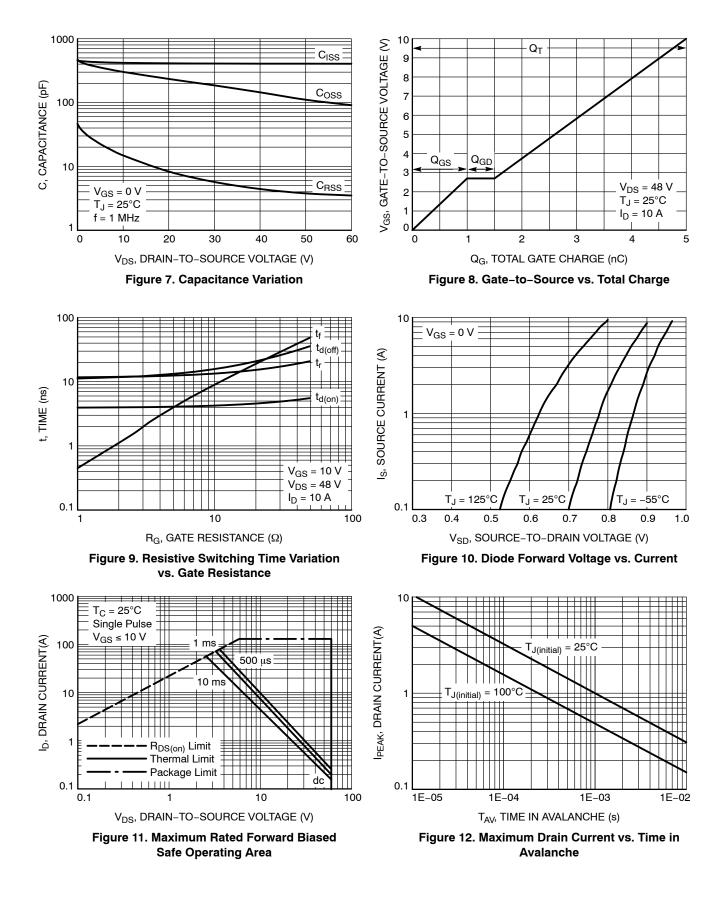
V _{SD}	Forward Diode Voltage	V _{GS} = 0 V, I _S = 10 A	$T_J = 25^{\circ}C$		0.9	1.2	V
		I _S = 10 A	T _J = 125°C		0.8		v
t _{RR}	Reverse Recovery Time				18		
t _a	Charge Time	V_{GS} = 0 V, dI_S/dt = 100 A/µs, I_S = 10 A			9.0		ns
t _b	Discharge Time				9.0		
Q _{RR}	Reverse Recovery Charge				7.0		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \,\mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

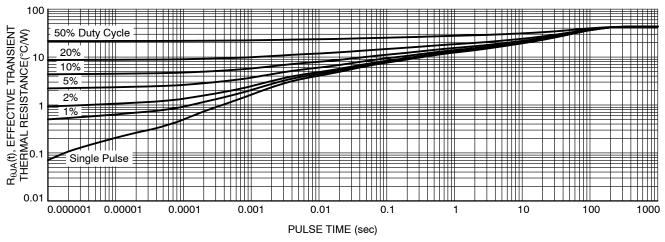


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C682NLT1G	5C682L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C682NLT3G	5C682L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C682NLAFT1G	5C682L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C682NLWFAFT1G	682LWF	DFNW5 (Pb-Free)	1500 / Tape & Reel

DEVICE ORDERING INFORMATION

DISCONTINUED (Note 6)

NVMFS5C682NLWFT3G	682LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C682NLWFT1G	682LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

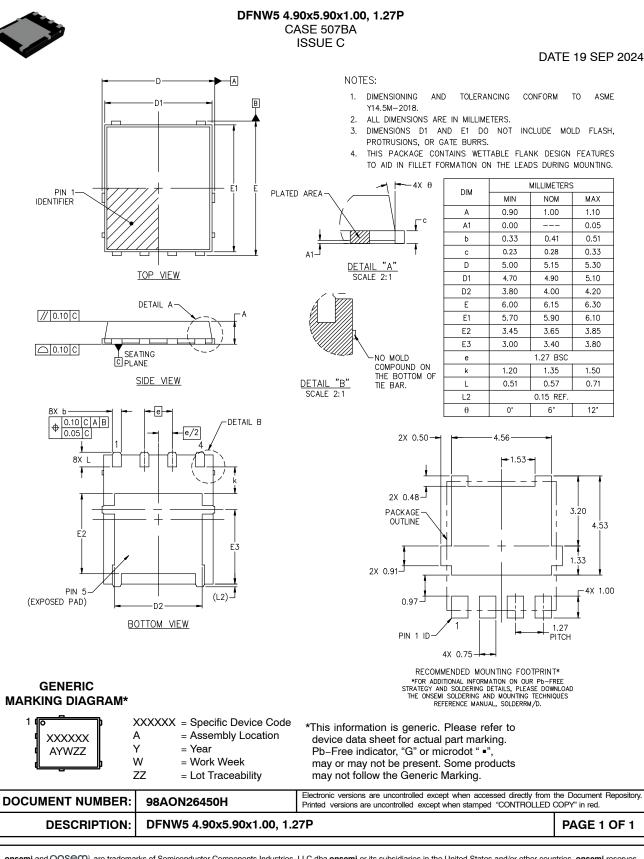
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

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